



Docket No. . 1232-4421US1 U.S. Serial No. 09/664,715

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

UEHARA et al.

Serial No.:

09/664,715

Group Art

1746

Filed

Examiner:

Unknown

For

September 19, 2000

WAFER PROCESSING APPARATUS, WAFER PROCESSING METHOD, AND

SEMICONDUCTOR SUBSTRATE FABRICATION METHOD

SUPPLEMENTAL TO SECOND INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents 2900 Crystal Dr. Arlington, VA 22202-3513

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NOV 3:0 2001

Sir:

Applicants submit this Supplemental To Second Information Disclosure Statement to correct typographical errors contained in the PTO-1449 form filed on September 21, 2001. Specifically, EP3257826, EP1304733 and EP 8316182 should be JP3-257826, JP1-304733 and JP 8-316182 respectively.

A new PTO-1449 form is attached herewith to replace the PTO-1449 form filed on September 21, 2001. Copies of the references are not attached because they were submitted with the Second Information Disclosure Statement on September 21, 2001.

This document is being filed prior to a first Office Action. No fee is believed due by this filing.

The Commissioner is hereby authorized to charge any additional fees which may be

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required for this Information Disclosure Statement, or credit any overpayment to Deposit Account No. <u>13-4503</u>, Order No. <u>1232-4421US1</u>.

Respectfully submitted,

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Dated: November 29, 2001

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